

ENCLOSURE FOR ELECTRONIC EQUIPMENT

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- European:

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Abstract of JP2000286565

PROBLEM TO BE SOLVED: To provide an enclosure for electric equipment for preventing warpage or peeling from being generated.

SOLUTION: An aluminum plate 11 and a resin layer 12 are joined via a nonwoven fabric (a fiber structure made of thermoplastic resin) 13.

The nonwoven fabric 13 acts as an adhesive and adheres to the aluminum plate 11 in a point or line. In this manner, by providing a nonadhesive part, the net structure of the nonwoven fabric remains deformed, thus absorbing the shrinkage difference between the aluminum plate 11 and the resin layer 12 for preventing warpage from being generated easily.

